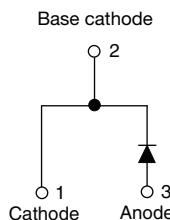
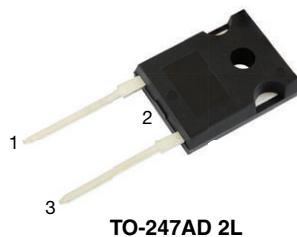


Hyperfast Rectifier, 75 A FRED Pt® G5



FEATURES

- Hyperfast and optimized Q_{rr}
- Best in class forward voltage drop and switching losses trade off
- Optimized for high speed operation
- 175 °C maximum operating junction temperature
- Polyimide passivation
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

PRIMARY CHARACTERISTICS

$I_{F(AV)}$	75 A
V_R	600 V
V_F at I_F at 125 °C	1.4 V
t_{rr} (typ.)	29
I_{FSM}	565
T_J max.	175 °C
Package	TO-247AD 2L
Circuit configuration	Single

DESCRIPTION / APPLICATIONS

Featuring a unique combination of low conduction and switching losses, this rectifier is the right choice for soft switched and resonant converters, as well as medium frequency hard switching converters. This device is specifically designed to improve efficiency of high speed LLC output rectification stages of EV / HEV battery charging stations and high frequency stages of UPS applications.

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Repetitive peak reverse voltage	V_{RRM}		600	V
Average rectified forward current	$I_{F(AV)}$	$T_C = 103$ °C, $D = 0.50$	75	
Non-repetitive peak surge current	I_{FSM}	$T_C = 25$ °C, $t_p = 10$ ms, sine wave	565	A
Repetitive peak forward current	I_{FRM}	$T_C = 103$ °C, $D = 0.50$, $f = 20$ kHz	150	
Operating junction and storage temperature	T_J , T_{Stg}		-55 to +175	°C

ELECTRICAL SPECIFICATIONS ($T_J = 25$ °C unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	V_{BR} , V_R	$I_R = 100$ µA	600	-	-	
Forward voltage	V_F	$I_F = 75$ A	-	1.6	2.2	V
		$I_F = 75$ A, $T_J = 125$ °C	-	1.4	-	
Reverse leakage current	I_R	$V_R = V_R$ rated	-	-	25	µA
		$T_J = 125$ °C, $V_R = V_R$ rated	-	-	500	
Junction capacitance	C_T	$V_R = 200$ V	-	96	-	pF
Series inductance	L_S	Measured to lead 5 mm from package body	-	8	-	nH

DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Reverse recovery time	t_{rr}	$I_F = 1.0 \text{ A}$, $dI_F/dt = 100 \text{ A}/\mu\text{s}$, $V_R = 30 \text{ V}$	-	29	-	ns
		$T_J = 25^\circ\text{C}$	-	44	-	
		$T_J = 125^\circ\text{C}$	-	69	-	
Peak recovery current	I_{RRM}	$T_J = 25^\circ\text{C}$	-	18	-	A
		$T_J = 125^\circ\text{C}$	-	42	-	
		$I_F = 50 \text{ A}$, $dI_F/dt = 1000 \text{ A}/\mu\text{s}$, $V_R = 400 \text{ V}$	-	484	-	
Reverse recovery charge	Q_{rr}	$T_J = 25^\circ\text{C}$	-	1731	-	nC
		$T_J = 125^\circ\text{C}$	-	573	-	
		$I_F = 75 \text{ A}$, $dI_F/dt = 1000 \text{ A}/\mu\text{s}$, $V_R = 400 \text{ V}$	-	2048	-	
Reverse recovery time	t_{rr}	$T_J = 25^\circ\text{C}$	-	48	-	ns
		$T_J = 125^\circ\text{C}$	-	75	-	
		$T_J = 25^\circ\text{C}$	-	21	-	A
Peak recovery current	I_{RRM}	$T_J = 125^\circ\text{C}$	-	46	-	
		$T_J = 25^\circ\text{C}$	-	573	-	
		$T_J = 125^\circ\text{C}$	-	2048	-	
Reverse recovery charge	Q_{rr}	$T_J = 25^\circ\text{C}$	-	484	-	nC
		$T_J = 125^\circ\text{C}$	-	1731	-	
		$T_J = 25^\circ\text{C}$	-	573	-	

THERMAL - MECHANICAL SPECIFICATIONS

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal resistance, junction-to-case	R_{thJC}		-	-	0.5	$^\circ\text{C}/\text{W}$
Weight			-	5.5	-	g
			-	0.2	-	oz.
Mounting torque			6 (5)	-	12 (10)	$\text{kgf} \cdot \text{cm}$ ($\text{lbf} \cdot \text{in}$)
Maximum junction and storage temperature range	T_J , T_{Stg}		-55	-	175	$^\circ\text{C}$
Marking device		Case style: TO-247AD 2L				E5PX7506L

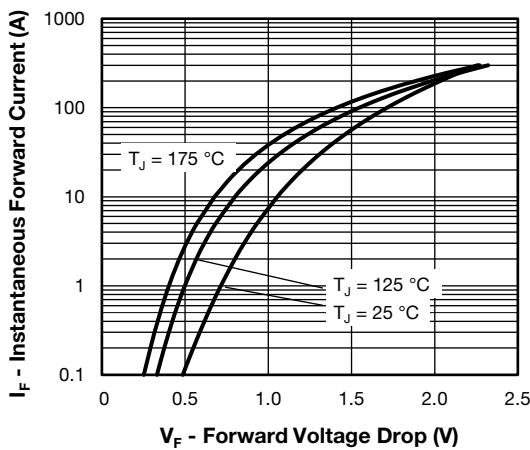


Fig. 1 - Forward Voltage Drop Characteristics, Per Leg

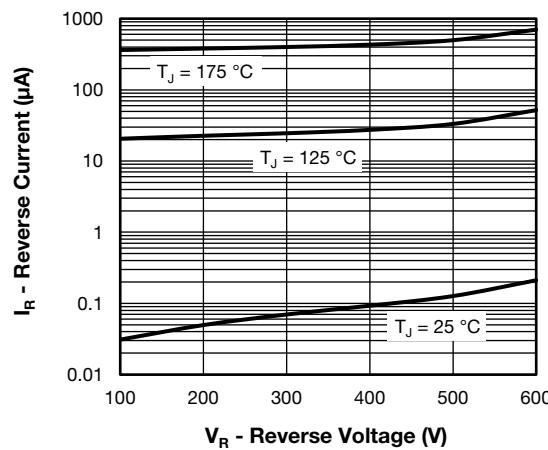


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage, Per Leg

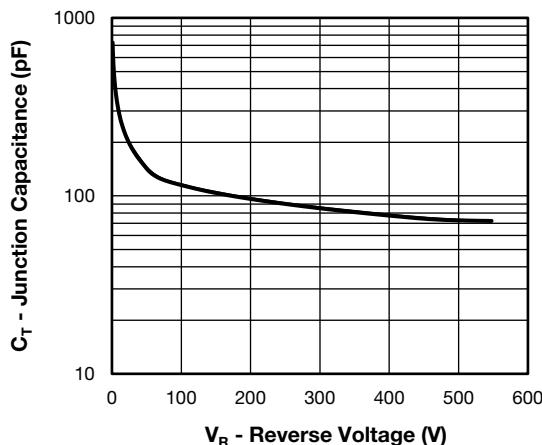


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage, Per Leg

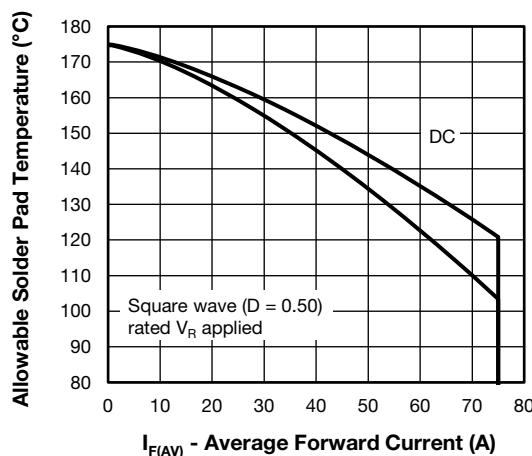


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current, Per Leg

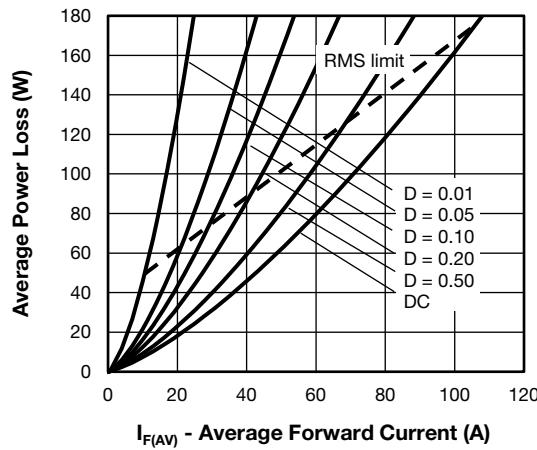


Fig. 5 - Forward Power Loss Characteristics, Per Leg

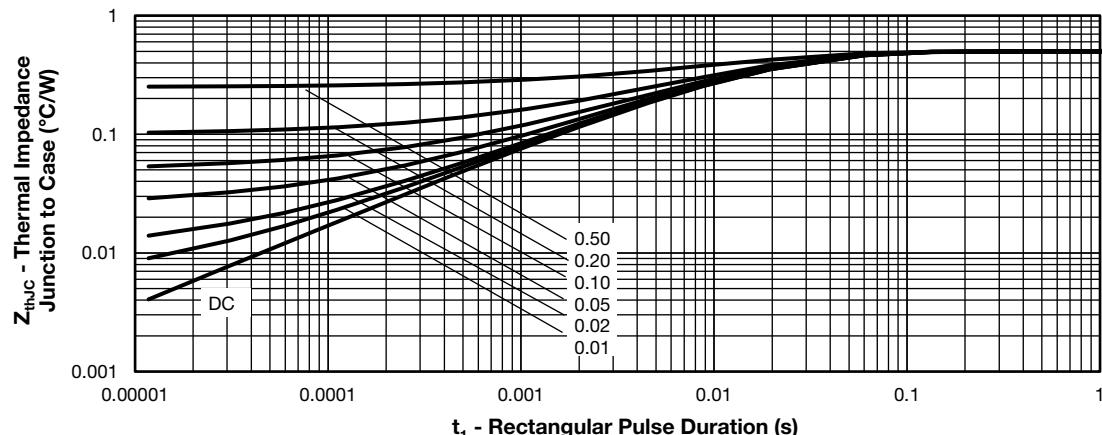


Fig. 6 - Transient Thermal Impedance, Junction to Case, Per Leg

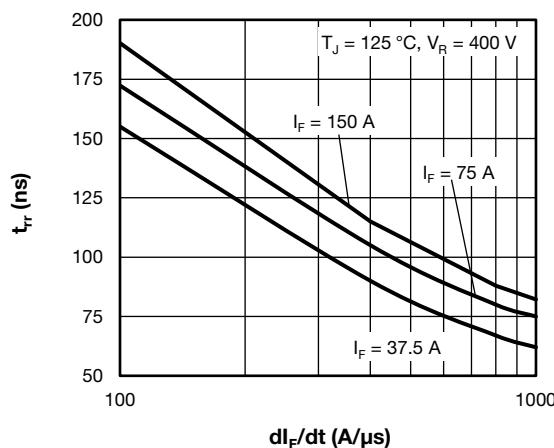


Fig. 7 - Typical Reverse Recovery Time vs. dI_F/dt , Per Leg

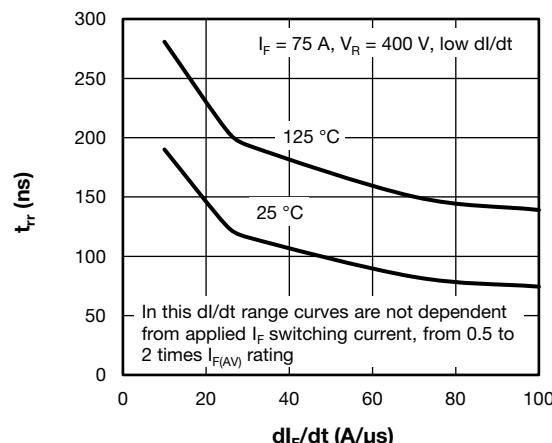


Fig. 10 - Typical Reverse Recovery Time vs. dI_F/dt , Per Leg

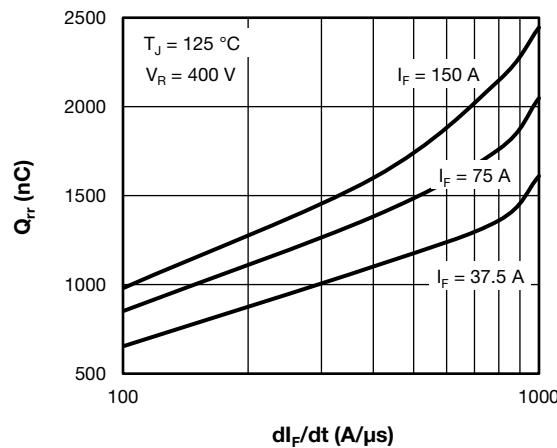


Fig. 8 - Typical Reverse Recovery Charge vs. dI_F/dt , Per Leg

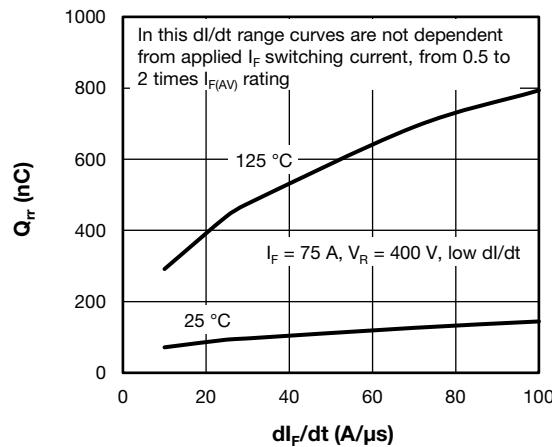


Fig. 11 - Typical Reverse Recovery Charge vs. dI_F/dt , Per Leg

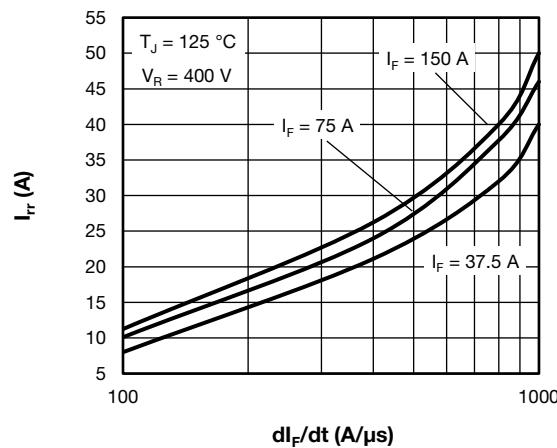


Fig. 9 - Typical Reverse Recovery Current vs. dI_F/dt , Per Leg

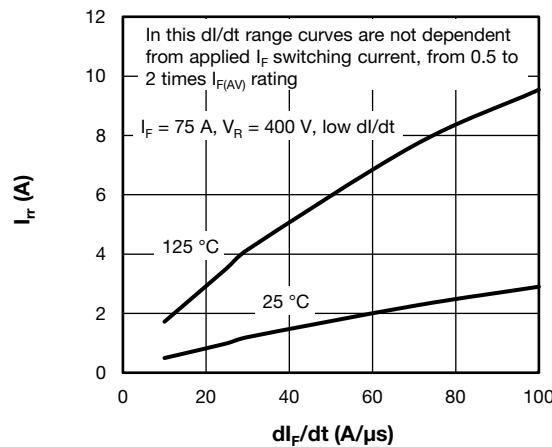


Fig. 12 - Typical Reverse Recovery Current vs. dI_F/dt , Per Leg

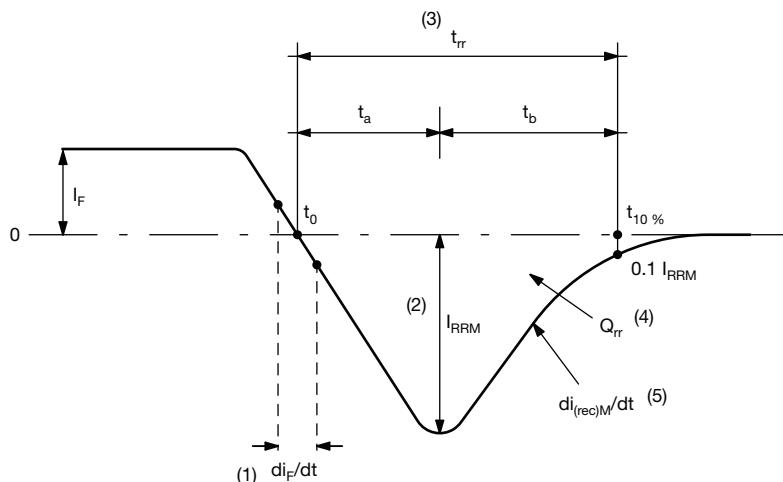


Fig. 13 - Reverse Recovery Waveform and Definitions

Notes

- (1) di_F/dt - rate of change of current through zero crossing
- (2) I_{RRM} - peak reverse recovery current
- (3) t_{rr} - reverse recovery time measured from t_0 , crossing point of negative going I_F , to point $t_{10\%}$, $0.1 I_{RRM}$
- (4) Q_{rr} - area under curve defined by t_0 and $t_{10\%}$

$t_{10\%}$

$$Q_{rr} = \int_{t_0}^{t_{10\%}} I(t) dt$$

- (5) $di_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

ORDERING INFORMATION TABLE

Device code	VS-	E	5	P	X	75	06	L	-N3
	1	2	3	4	5	6	7	8	9

- 1** - Vishay Semiconductors product
- 2** - E = single diode
- 3** - 5 = Fred generation 5
- 4** - Package:
P = TO-247 package
X = hyperfast recovery
- 5** - Current rating (75 = 75 A)
- 6** - Voltage rating (06 = 600 V)
- 7** - Package: L = long lead (TO-247AD)
- 8** - Environmental digit:
-N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

ORDERING INFORMATION (Example)

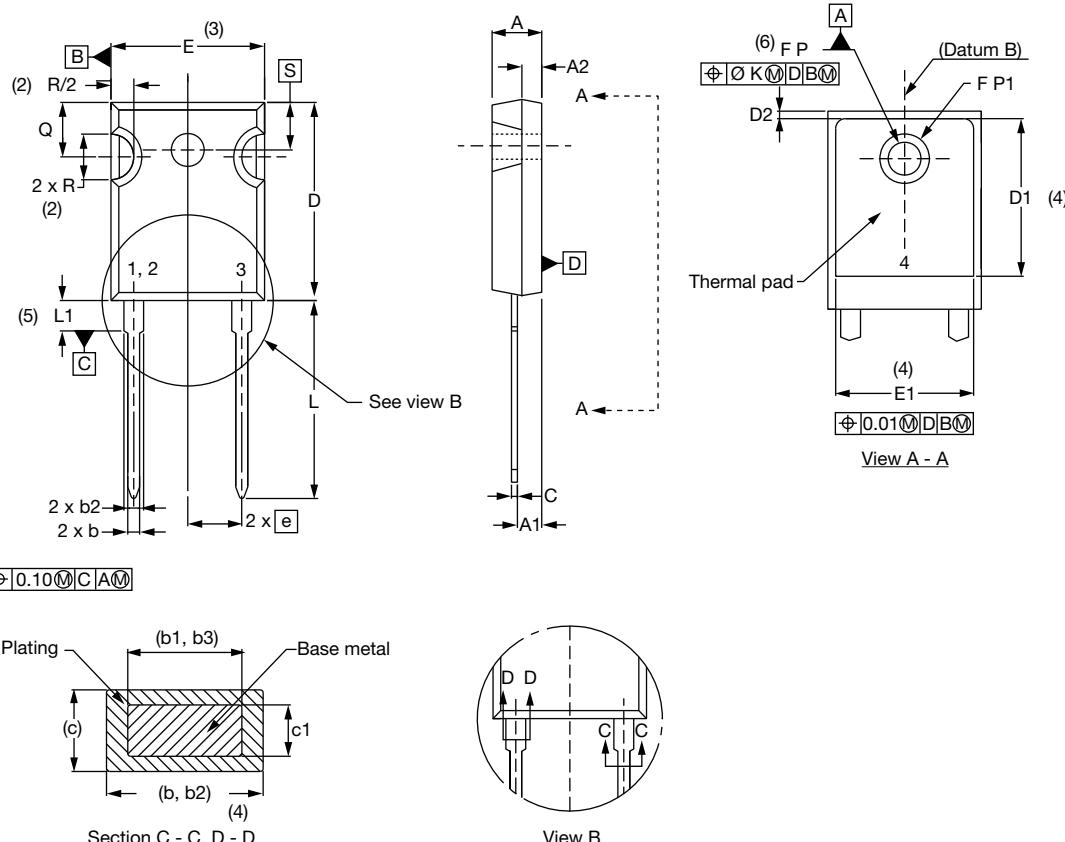
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-E5PX7506L-N3	25	500	Antistatic plastic tube

LINKS TO RELATED DOCUMENTS

Dimensions	www.vishay.com/doc?95536
Part marking information	www.vishay.com/doc?295648

TO-247AD 2L

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES		SYMBOL	MILLIMETERS		INCHES		NOTES	
	MIN.	MAX.	MIN.	MAX.				MIN.	MAX.	MIN.	MAX.		
A	4.65	5.31	0.183	0.209			E	15.29	15.87	0.602	0.625	3	
A1	2.21	2.59	0.087	0.102			E1	13.46	-	0.53	-		
A2	1.50	2.49	0.059	0.098				5.46 BSC		0.215 BSC			
b	0.99	1.40	0.039	0.055				0.254		0.010			
b1	0.99	1.35	0.039	0.053				Ø K					
b2	1.65	2.39	0.065	0.094				L	19.81	20.32	0.780	0.800	
b3	1.65	2.34	0.065	0.092				L1	3.71	4.29	0.146	0.169	
c	0.38	0.89	0.015	0.035				Ø P	3.56	3.66	0.14	0.144	
c1	0.38	0.84	0.015	0.033				Ø P1	-	6.98	-	0.275	
D	19.71	20.70	0.776	0.815	3			Q	5.31	5.69	0.209	0.224	
D1	13.08	-	0.515	-	4			R	4.52	5.49	0.178	0.216	
D2	0.51	1.35	0.020	0.053				S	5.51 BSC		0.217 BSC		

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4

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